



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

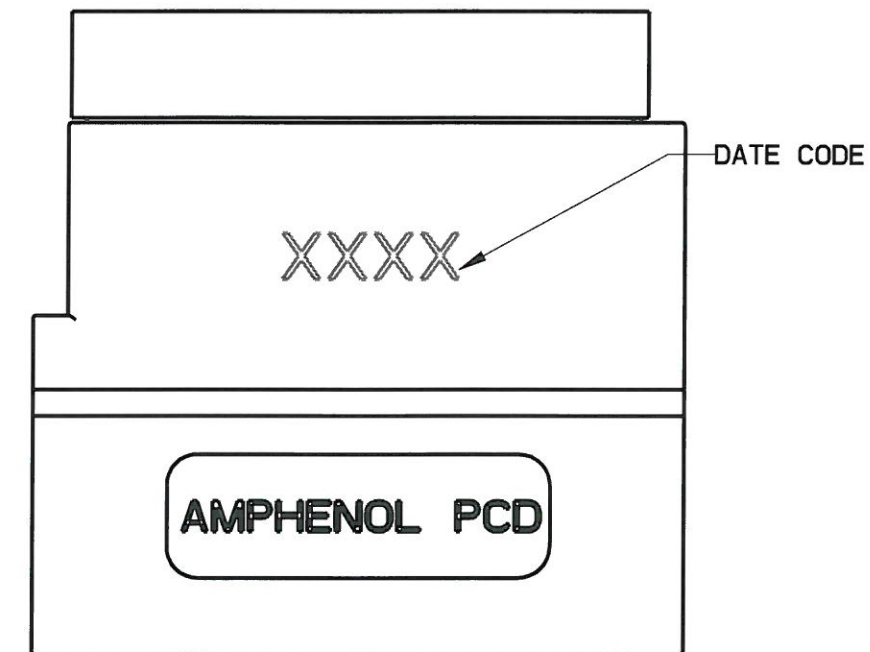
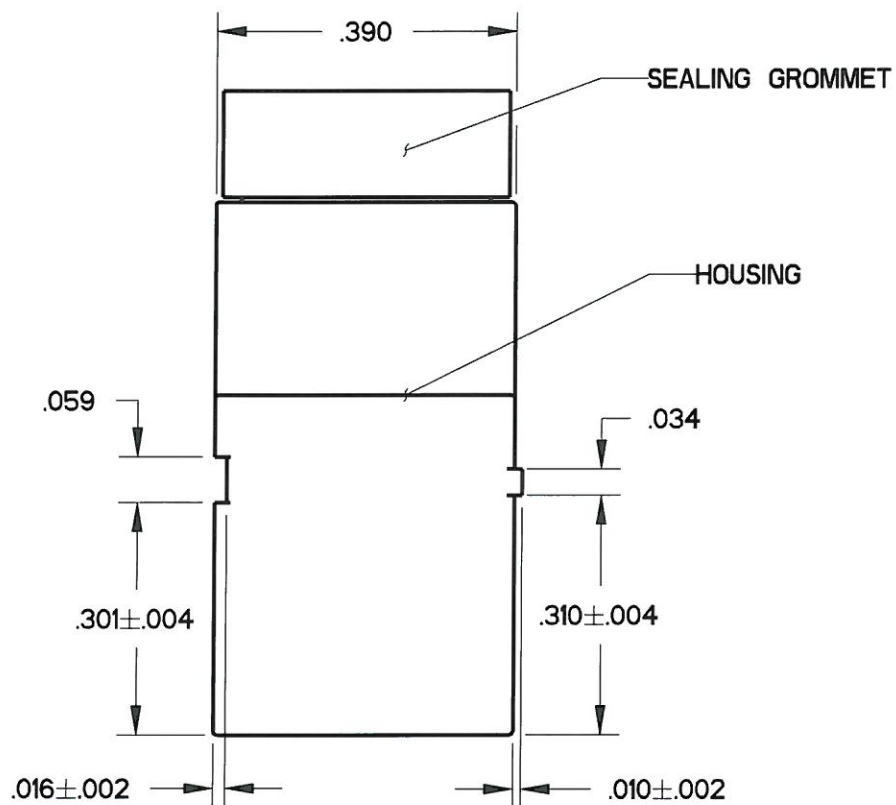
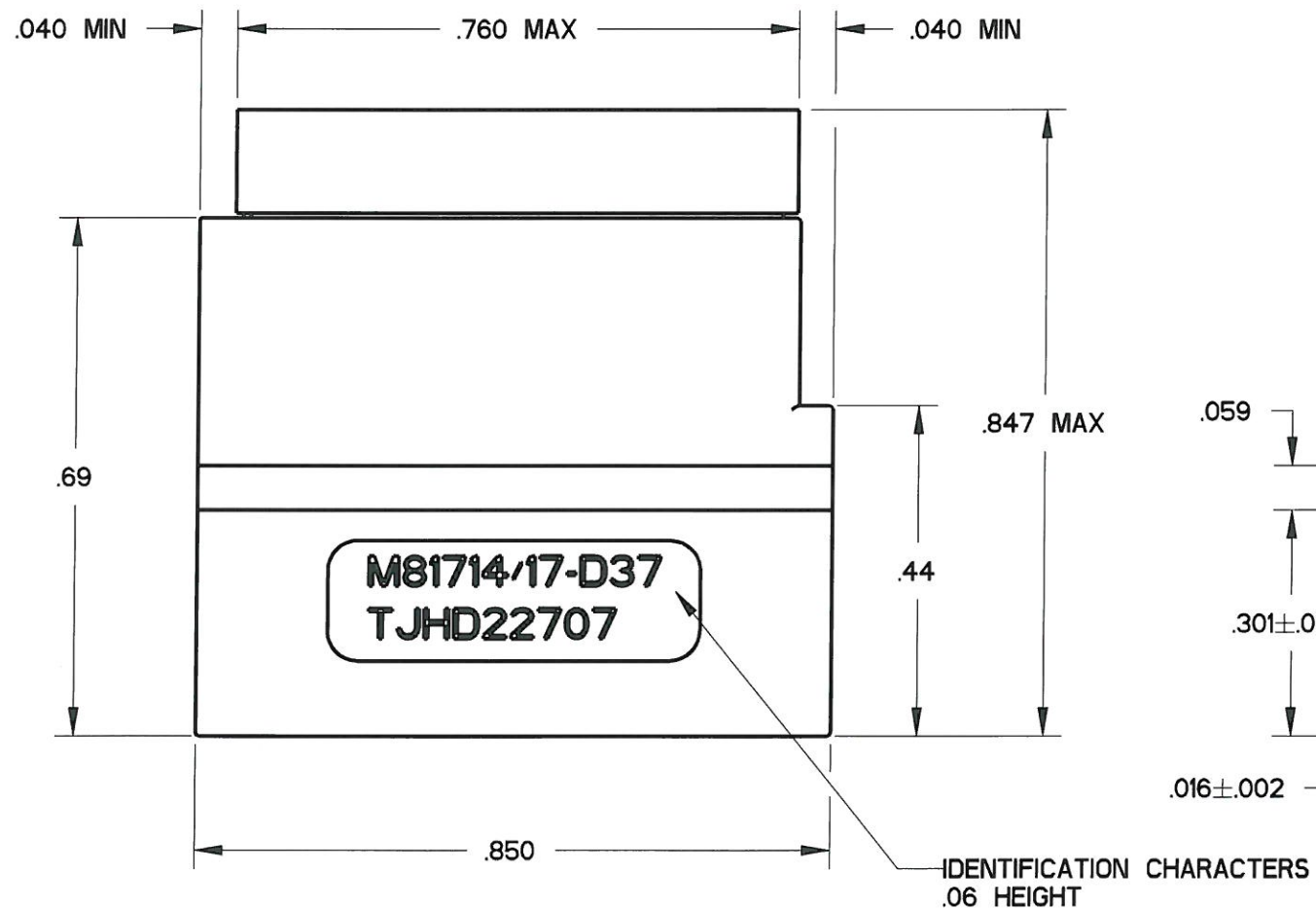
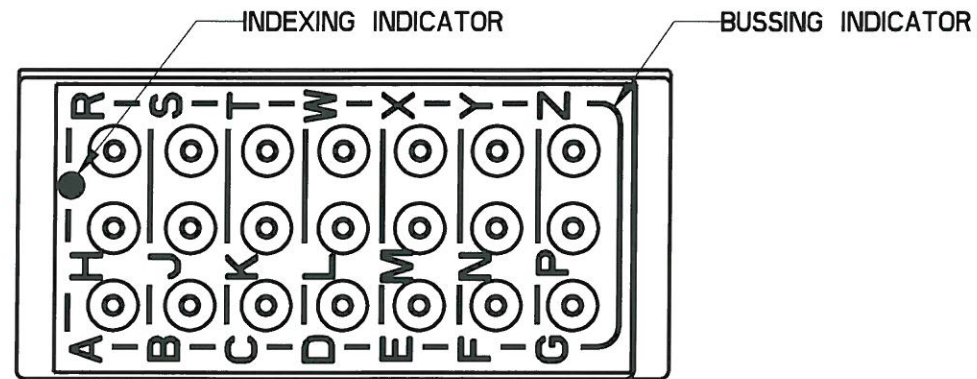
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REV	ECN	APP'D
-	2939	JR 2/7/97
A	3043	AP 7/22/97
B	3338	JR 7/16/98
C	6200	JT 8/25/08
D	6349	<i>[Signature]</i> 9/27/10



- NOTES:
 1. MATERIAL:
 HOUSING - THERMOPLASTIC, COLOR: BLACK.
 GROMMET - SILICONE RUBBER, COLOR: BLUE
 INTERNAL BUSSING - COPPER ALLOY
 2. MODULE ACCEPTS M39029/1-507 PIN CONTACTS

PART NO.	INCLUDED W/ MODULE
TJHD22607	MODULE ONLY
TJHD22707	22 EACH M39029/1-507 PIN CONTACTS 2 EACH MS27488-22 SEALING PLUGS

DIMENSIONS	TOLERANCES	PROJECTION	Amphenol Pcd SPECIFICATION DRAWING	
ANSI Y14.5M UNITS: INCHES Pro/E FILE	.XX ±0.01 .XXX ±0.005 ANGLES ±2.0°		ENGR A. PATRIE 03/08/06	CHKD <i>[Signature]</i> 9/27/10
ORIGINAL 	THIS DOCUMENT CONTAINS PROPRIETARY INFORMATION WHICH IS THE CONFIDENTIAL PROPERTY OF AMPHENOL PCD INC., BEVERLY, MA		APPD <i>[Signature]</i> 9/27/10	

TITLE			
MODULE, TERMINAL JUNCTION SIZE 22, HI-DENSITY D37 BUS ARRANGEMENT			
SIZE B	DWG NO. TJHD22607	REV D	
CODE: 58982	SCALE: 4:1	SHEET 1 OF 1	

TJHD22607

TJHD22607